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Team Nexperia

74LVC16244A; 74LVCH16244A

16-bit buffer/line driver; 5 V input/output tolerant; 3-state

Rev. 13 — 7 February 2014

Product data sheet

1. General description

The 74LVC16244A; 74LVCH16244A are 16-bit non-inverting buffer/line drivers with 3-state bus compatible outputs. The device can be used as four 4-bit buffers, two 8-bit buffers or one 16-bit buffer. It features four output enable inputs, (1OE to 4OE) each controlling four of the 3-state outputs. A HIGH on nOE causes the outputs to assume a high-impedance OFF-state.

Inputs can be driven from either 3.3 V or 5 V devices. When disabled, up to 5.5 V can be applied to the outputs. These features allow the use of these devices in mixed 3.3 V and 5 V applications.

The 74LVCH16244A bus hold on data inputs eliminates the need for external pull-up resistors to hold unused inputs.

2. Features and benefits

- 5 V tolerant inputs/outputs for interfacing with 5 V logic
- Wide supply voltage range from 1.2 V to 3.6 V
- CMOS low power consumption
- Multibyte flow-through standard pin-out architecture
- Low inductance multiple power and ground pins for minimum noise and ground bounce
- Direct interface with TTL levels
- High-impedance when V_{CC} = 0 V
- All data inputs have bus hold. (74LVCH16244A only)
- Complies with JEDEC standard:
 - ◆ JESD8-7A (1.65 V to 1.95 V)
 - ◆ JESD8-5A (2.3 V to 2.7 V)
 - ◆ JESD8-C/JESD36 (2.7 V to 3.6 V)
- ESD protection:
 - HBM JESD22-A114F exceeds 2000 V
 - MM JESD22-A115-B exceeds 200 V
 - ◆ CDM JESD22-C101E exceeds 1000 V
- Specified from -40 °C to +85 °C and -40 °C to +125 °C

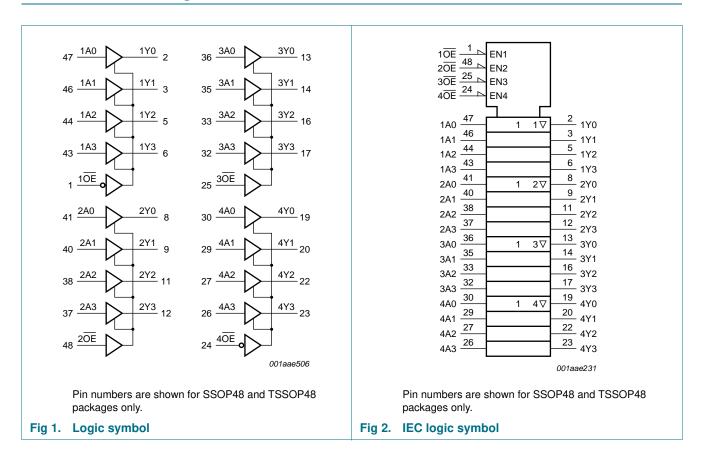


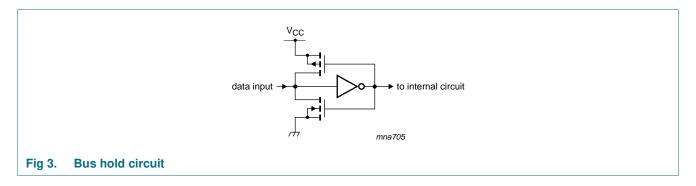
3. Ordering information

Table 1. Ordering information

Type number	Temperature range	Package						
		Name	Description	Version				
74LVC16244ADL	–40 °C to +125 °C	SSOP48	plastic shrink small outline package; 48 leads;	SOT370-1				
74LVCH16244ADL			body width 7.5 mm					
74LVC16244ADGG	–40 °C to +125 °C	TSSOP48	plastic thin shrink small outline package;	SOT362-1				
74LVCH16244ADGG			48 leads; body width 6.1 mm					
74LVC16244AEV	–40 °C to +125 °C	VFBGA56	plastic very thin fine-pitch ball grid array package;	SOT702-1				
74LVCH16244AEV			56 balls; body $4.5 \times 7 \times 0.65$ mm					
74LVC16244ABX	–40 °C to +125 °C	HXQFN60	HXQFN60 plastic compatible thermal enhanced extremely					
74LVCH16244ABX			thin quad flat package; no leads; 60 terminals; body $4 \times 6 \times 0.5$ mm					

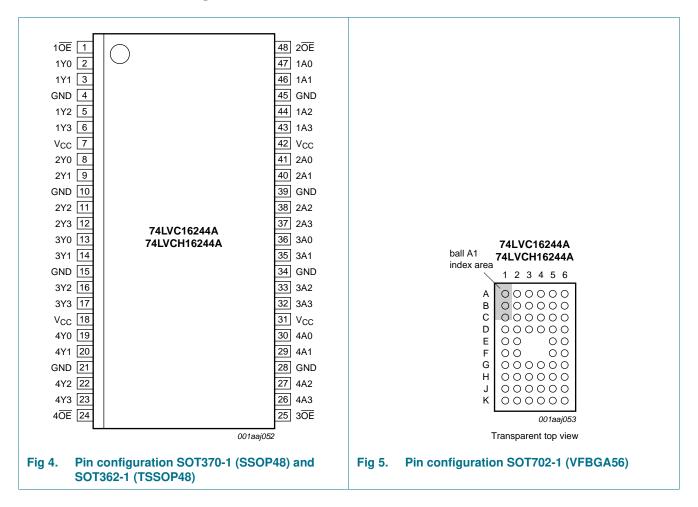
4. Functional diagram





5. Pinning information

5.1 Pinning



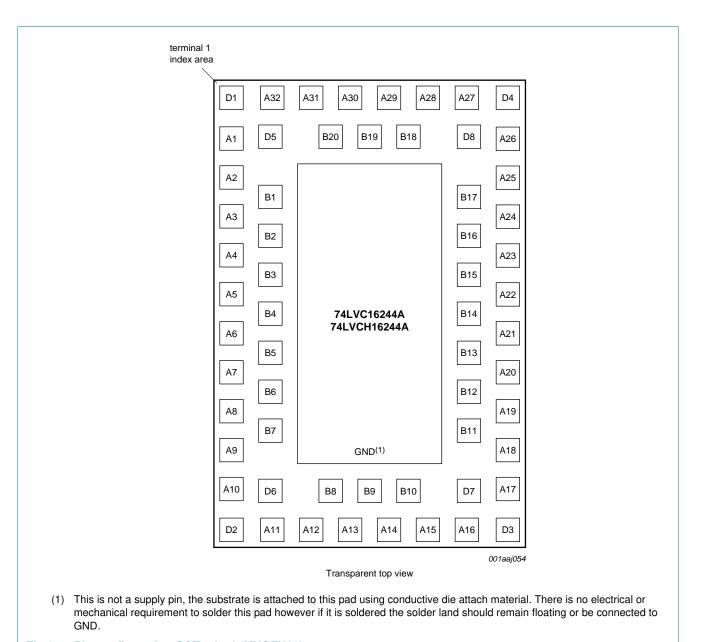


Fig 6. Pin configuration SOT1134-2 (HXQFN60)

5.2 Pin description

Table 2. Pin description

Symbol	Pin		Description	
	SOT370-1 and SOT362-1	SOT702-1	SOT1134-2	
1 <u>0E</u> , 2 <u>0E</u> , 30E, 40E	1, 48, 25, 24	A1, A6, K6, K1	A30, A29, A14, A13	output enable input (active LOW)
1Y0 to 1Y3	2, 3, 5, 6	B2, B1, C2, C1	B20, A31, D5, D1	data output
2Y0 to 2Y3	8, 9, 11, 12	D2, D1, E2, E1	A2, B2, B3, A5	data output
3Y0 to 3Y3	13, 14, 16, 17	F1, F2, G1, G2	A6, B5, B6, A9	data output
4Y0 to 4Y3	19, 20, 22, 23	H1, H2, J1, J2	D2, D6, A12, B8	data output
GND	4, 10, 15, 21, 28, 34, 39, 45	B3, B4, D3, D4, G3, G4, J3, J4	A32, A3, A8, A11, A16, A19, A24, A27	ground (0 V)
V _{CC}	7, 18, 31, 42	C3, C4, H3, H4	A1, A10, A17, A26	supply voltage
1A0 to 1A3	47, 46, 44, 43	B5, B6, C5, C6	B18, A28, D8, D4	data input
2A0 to 2A3	41, 40, 38, 37	D5, D6, E5, E6	A25, B16, B15, A22	data input
3A0 to 3A3	36, 35, 33, 32	F6, F5, G6, G5	A21, B13, B12, A18	data input
4A0 to 4A3	30, 29, 27, 26	H6, H5, J6, J5	D3, D7, A15, B10	data input
n.c.	-	A2, A3, A4, A5, K2, K3, K4, K5	A4, A7, A20, A23, B1, B4, B7, B9, B11, B14, B17, B19	not connected

6. Functional description

Table 3. Function table[1]

Control	Input	Output
nOE	nAn	nYn
L	L	L
L	Н	Н
Н	X	Z

^[1] H = HIGH voltage level; L = LOW voltage level; X = don't care; Z = high-impedance OFF-state.

7. Limiting values

Table 4. Limiting values

In accordance with the Absolute Maximum Rating System (IEC 60134). Voltages are referenced to GND (ground = 0 V).

		, , ,			
Symbol	Parameter	Conditions	Min	Max	Unit
V_{CC}	supply voltage		-0.5	+6.5	V
I _{IK}	input clamping current	V _I < 0 V	-50	-	mA
VI	input voltage		<u>[1]</u> –0.5	+6.5	V
I _{OK}	output clamping current	$V_O > V_{CC}$ or $V_O < 0$ V	-	±50	mA
Vo	output voltage	output HIGH or LOW	<u>[2]</u> –0.5	$V_{CC} + 0.5$	V
		output 3-state	<u>[2]</u> –0.5	+6.5	V
Io	output current	$V_O = 0 V \text{ to } V_{CC}$	-	±50	mA
I _{CC}	supply current		-	100	mA
I _{GND}	ground current		-100	-	mA
T _{stg}	storage temperature		- 65	+150	°C
P _{tot}	total power dissipation	$T_{amb} = -40 ^{\circ}\text{C} \text{ to } +125 ^{\circ}\text{C};$			
		(T)SSOP48 package	[3] _	500	mW
		VFBGA56 package	[4] -	1000	mW
		HXQFN60 package	[4] -	1000	mW

^[1] The minimum input voltage ratings may be exceeded if the input current ratings are observed.

8. Recommended operating conditions

Table 5. Recommended operating conditions

Symbol	Parameter	Conditions	Min	Тур	Max	Unit
V_{CC}	supply voltage		1.65	-	3.6	V
		functional	1.2	-	3.6	V
V _I	input voltage		0	-	5.5	V
V _O	output voltage	output HIGH or LOW	0	-	V_{CC}	V
		output 3-state	0	-	5.5	V
T _{amb}	ambient temperature	in free air	-40	-	+125	°C
$\Delta t/\Delta V$	input transition rise and fall rate	$V_{CC} = 1.2 \text{ V to } 2.7 \text{ V}$	0	-	20	ns/V
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	0	-	10	ns/V

^[2] The output voltage ratings may be exceeded if the output current ratings are observed.

^[3] Above 60 °C the value of Ptot derates linearly with 5.5 mW/K.

^[4] Above 70 °C the value of P_{tot} derates linearly with 1.8 mW/K.

9. Static characteristics

Table 6. Static characteristics

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +8	35 °C	-40 °C to	–40 °C to +125 °C		
			Min	Typ[1]	Max	Min	Max		
V _{IH}	HIGH-level input	V _{CC} = 1.2 V	1.08	-	-	1.08	-	V	
	voltage	V _{CC} = 1.65 V to 1.95 V	$0.65 \times V_{CC}$	-	-	$0.65 \times V_{CC}$	-	V	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	1.7	-	-	1.7	-	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	2.0	-	-	2.0	-	V	
V _{IL}	LOW-level input	V _{CC} = 1.2 V	-	-	0.12	-	0.12	V	
	voltage	V _{CC} = 1.65 V to 1.95 V	-	-	$0.35 \times V_{CC}$	-	$0.35 \times V_{CC}$	V	
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$	-	-	0.7	-	0.7	V	
		$V_{CC} = 2.7 \text{ V to } 3.6 \text{ V}$	-	-	0.8	-	0.8	V	
V_{OH}	HIGH-level	$V_I = V_{IH}$ or V_{IL}							
	output voltage	$I_O = -100 \ \mu A;$ $V_{CC} = 1.65 \ V$ to 3.6 V	$V_{\text{CC}}-0.2$	-	-	$V_{CC}-0.3$	-	V	
		$I_{O} = -4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	1.2	-	-	1.05	-	V	
		$I_{O} = -8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	1.8	-	-	1.65	-	V	
		$I_{O} = -12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	2.2	-	-	2.05	-	V	
		$I_{O} = -18 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.4	-	-	2.25	-	V	
		$I_{O} = -24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	2.2	-	-	2.0	-	V	
V _{OL} LOW-level		$V_I = V_{IH}$ or V_{IL}							
	output voltage	$I_O = 100 \mu A;$ $V_{CC} = 1.65 V \text{ to } 3.6 V$	-	-	0.2	-	0.3	V	
		$I_O = 4 \text{ mA}; V_{CC} = 1.65 \text{ V}$	-	-	0.45	-	0.65	V	
		$I_O = 8 \text{ mA}; V_{CC} = 2.3 \text{ V}$	-	-	0.6	-	8.0	V	
		$I_O = 12 \text{ mA}; V_{CC} = 2.7 \text{ V}$	-	-	0.4	-	0.6	V	
		$I_O = 24 \text{ mA}; V_{CC} = 3.0 \text{ V}$	-	-	0.55	-	0.8	V	
I _I	input leakage current	$V_{CC} = 3.6 \text{ V};$ $V_{I} = 5.5 \text{ V or GND}$	-	±0.1	±5	-	±20	μΑ	
l _{OZ}	OFF-state output current [2]	$V_I = V_{IH}$ or V_{IL} ; $V_{CC} = 3.6$ V; $V_O = 5.5$ V or GND;	-	±0.1	±5	-	±20	μΑ	
I _{OFF}	power-off leakage current	$V_{CC} = 0 \text{ V}; V_{I} \text{ or } V_{O} = 5.5 \text{ V}$	-	±0.1	±10	-	±20	μΑ	
I _{CC}	supply current	$V_{CC} = 3.6 \text{ V};$ $V_I = V_{CC} \text{ or GND}; I_O = 0 \text{ A}$	-	0.1	20	-	80	μА	
Δl _{CC}	additional supply current	per input pin; $V_{CC} = 2.7 \text{ V to } 3.6 \text{ V};$ $V_I = V_{CC} - 0.6 \text{ V};$ $I_O = 0 \text{ A}$	-	5	500	-	5000	μΑ	
Cı	input capacitance	$V_{CC} = 0 \text{ V to } 3.6 \text{ V};$ $V_I = \text{GND to } V_{CC}$	-	5.0	-	-	-	pF	
I _{BHL}	bus hold LOW	$V_{CC} = 1.65; V_I = 0.58 \text{ V}$	10	-	-	10	-	μΑ	
	current [3][4]	$V_{CC} = 2.3; V_I = 0.7 \text{ V}$	30	-	-	25	-	μΑ	
		$V_{CC} = 3.0; V_1 = 0.8 \text{ V}$	75	-	-	60	-	μA	

74LVC_LVCH16244A

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Table 6. Static characteristics ... continued

At recommended operating conditions. Voltages are referenced to GND (ground = 0 V).

Symbol	Parameter	Conditions	-40	°C to +85	5 °C	-40 °C to	Unit	
			Min	Typ[1]	Max	Min	Max	
I _{BHH} bus hold HIGH current [3][4]	$V_{CC} = 1.65; V_I = 1.07 V$	-10	-	-	-10	-	μΑ	
	$V_{CC} = 2.3; V_I = 1.7 V$	-30	-	-	-25	-	μΑ	
		$V_{CC} = 3.0; V_I = 2.0 V$	-75	-	-	-60	-	μΑ
I _{BHLO}	bus hold LOW	V _{CC} = 1.95 V	200	-	-	200	-	μΑ
	overdrive current [3][5]	$V_{CC} = 2.7 \text{ V}$	300	-	-	300	-	μΑ
		V _{CC} = 3.6 V	500	-	-	500	-	μΑ
I _{BHHO}	bus hold HIGH	V _{CC} = 1.95 V	-200	-	-	-200	-	μΑ
	overdrive current [3][5]	V _{CC} = 2.7 V	-300	-	-	-300	-	μΑ
		$V_{CC} = 3.6 \text{ V}$	-500	-	-	-500	-	μА

^[1] All typical values are measured at V_{CC} = 3.3 V and T_{amb} = 25 °C.

10. Dynamic characteristics

Table 7. Dynamic characteristics

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		-40	°C to +8	5 °C	-40 °C to +125 °C		Unit
				Min	Typ[2]	Max	Min	Max	
t_{pd}	propagation	nAn to nYn; see Figure 7	[1]						
	delay	V _{CC} = 1.2 V		-	11.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		1.5	4.8	10.7	1.5	11.3	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.6	5.3	1.0	5.9	ns
	V _{CC} = 2.7 V		1.0	2.6	4.7	1.0	6.0	ns	
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.1	2.2	4.1	1.1	5.5	ns
t _{en}	enable time	nOE to nYn; see Figure 8	<u>[1]</u>						
		V _{CC} = 1.2 V		-	15.0	-	-	-	ns
		$V_{CC} = 1.65 \text{ V to } 1.95 \text{ V}$		1.5	6.2	12.1	1.5	12.7	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	3.5	6.4	1.0	7.1	ns
		$V_{CC} = 2.7 V$		1.0	3.3	5.8	1.0	7.5	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.0	2.8	4.6	1.0	6.0	ns
t _{dis}	disable time	nOE to nYn; see Figure 8	<u>[1]</u>						
		V _{CC} = 1.2 V		-	10.0	-	-	-	ns
		V _{CC} = 1.65 V to 1.95 V		2.5	4.4	8.7	2.5	9.4	ns
		$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		1.0	2.4	4.9	1.0	5.3	ns
		V _{CC} = 2.7 V		1.0	3.2	6.2	1.0	8.0	ns
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		1.8	3.1	5.2	1.8	6.5	ns

74LVC_LVCH16244A

^[2] The bus hold circuit is switched off when $V_1 > V_{\text{CC}}$ allowing 5.5 V on the input terminal.

^[3] Valid for data inputs only. Control inputs do not have a bus hold circuit.

^[4] The specified sustaining current at the data input holds the input below the specified V_I level.

^[5] The specified overdrive current at the data input forces the data input to the opposite logic input state.

 Table 7.
 Dynamic characteristics ...continued

Voltages are referenced to GND (ground = 0 V). For test circuit see Figure 9.

Symbol	Parameter	Conditions		–40 °C to +85 °C			-40 °C to +125 °C		Unit
				Min	Typ[2]	Max	Min	Max	
C _{PD} power dissipation capacitance	per input; $V_I = GND$ to V_{CC}	l							
	V _{CC} = 1.65 V to 1.95 V		-	4.8	-	-	-	pF	
	$V_{CC} = 2.3 \text{ V to } 2.7 \text{ V}$		-	8.3	-	-	-	pF	
		$V_{CC} = 3.0 \text{ V to } 3.6 \text{ V}$		-	11.4	-	-	-	pF

[1] t_{pd} is the same as t_{PLH} and t_{PHL} .

 t_{en} is the same as t_{PZL} and t_{PZH} .

 t_{dis} is the same as t_{PLZ} and t_{PHZ} .

- [2] Typical values are measured at T_{amb} = 25 °C and V_{CC} = 1.2 V, 1.8 V, 2.5 V, 2.7 V and 3.3 V respectively.
- [3] C_{PD} is used to determine the dynamic power dissipation (P_D in μW).

 $P_D = C_{PD} \times V_{CC}^2 \times f_i \times N + \Sigma (C_L \times V_{CC}^2 \times f_o)$ where:

 f_i = input frequency in MHz; f_o = output frequency in MHz

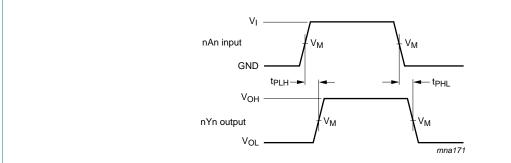
C_L = output load capacitance in pF

V_{CC} = supply voltage in Volts

N = number of inputs switching

 $\Sigma(C_L \times V_{CC}^2 \times f_o)$ = sum of the outputs.

11. Waveforms



Measurement points are given in Table 8.

Logic levels: V_{OL} and V_{OH} are typical output voltage levels that occur with the output load.

Fig 7. The input (nAn) to output (nYn) propagation delays

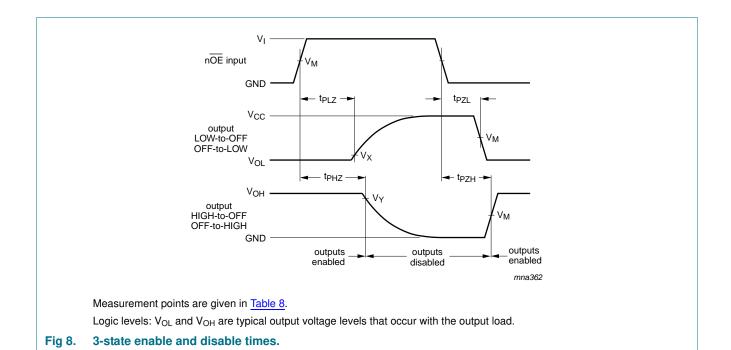
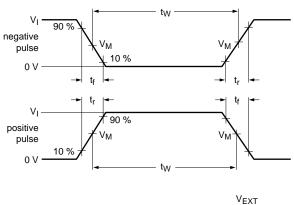
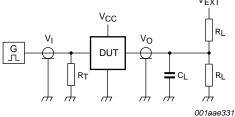


Table 8. Measurement points

Supply voltage	V _M	Input	Input						
V _{CC}		VI	$t_r = t_f$	V _X	V _Y				
1.2 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$				
1.65 V to 1.95 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns	$V_{OL} + 0.15 V$	$V_{OH}-0.15\ V$				
2.3 V to 2.7 V	$0.5 \times V_{CC}$	V_{CC}	≤ 2.5 ns	V _{OL} + 0.15 V	V _{OH} – 0.15 V				
2.7 V	1.5 V	2.7 V	≤ 2.5 ns	$V_{OL} + 0.3 V$	$V_{OH} - 0.3 V$				
3.0 V to 3.6 V	1.5 V	2.7 V	≤ 2.5 ns	V_{OL} + 0.3 V	$V_{OH}-0.3\ V$				





Test data is given in Table 9.

Definitions for test circuit:

 R_L = Load resistance.

C_L = Load capacitance including jig and probe capacitance.

 R_T = Termination resistance should be equal to output impedance Z_0 of the pulse generator.

V_{EXT} = External voltage for measuring switching times.

Fig 9. Test circuit for measuring switching times

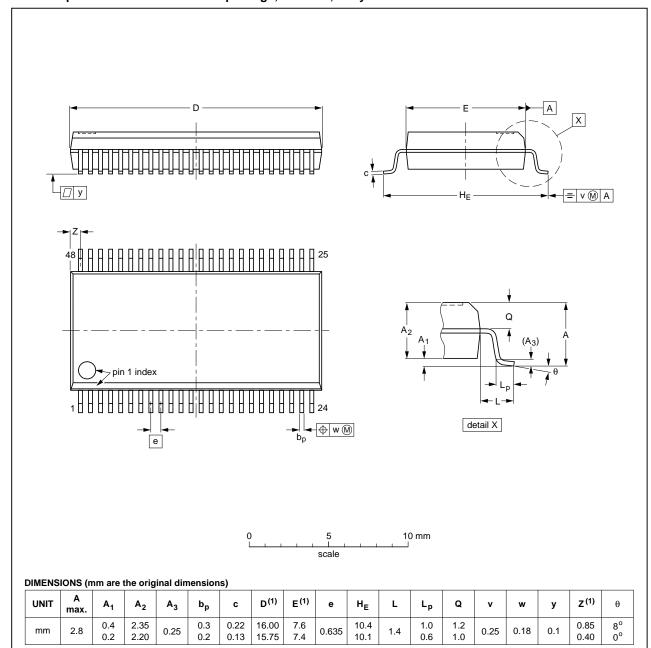
Table 9. Test data

Supply voltage	Input	Input		Load		V _{EXT}		
	VI	t _r , t _f	CL	RL	t _{PLH} , t _{PHL}	t_{PLZ} , t_{PZL}	t _{PHZ} , t _{PZH}	
1.2 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
1.65 V to 1.95 V	V_{CC}	≤ 2 ns	30 pF	1 kΩ	open	$2\times V_{CC}$	GND	
2.3 V to 2.7 V	V_{CC}	≤ 2 ns	30 pF	500Ω	open	$2\times V_{CC}$	GND	
2.7 V	2.7 V	≤ 2.5 ns	50 pF	500Ω	open	$2\times V_{CC}$	GND	
3.0 V to 3.6 V	2.7 V	≤ 2.5 ns	50 pF	500 Ω	open	$2\times V_{CC}$	GND	

12. Package outline

SSOP48: plastic shrink small outline package; 48 leads; body width 7.5 mm

SOT370-1



Note

1. Plastic or metal protrusions of 0.25 mm maximum per side are not included.

OUTLINE VERSION		REFER	ENCES	EUROPEAN ISSUE DAT			
	IEC	JEDEC	JEITA	PROJECTION	ISSUE DATE		
SOT370-1		MO-118			99-12-27 03-02-19		

Fig 10. Package outline SOT370-1 (SSOP48)

74LVC_LVCH16244A

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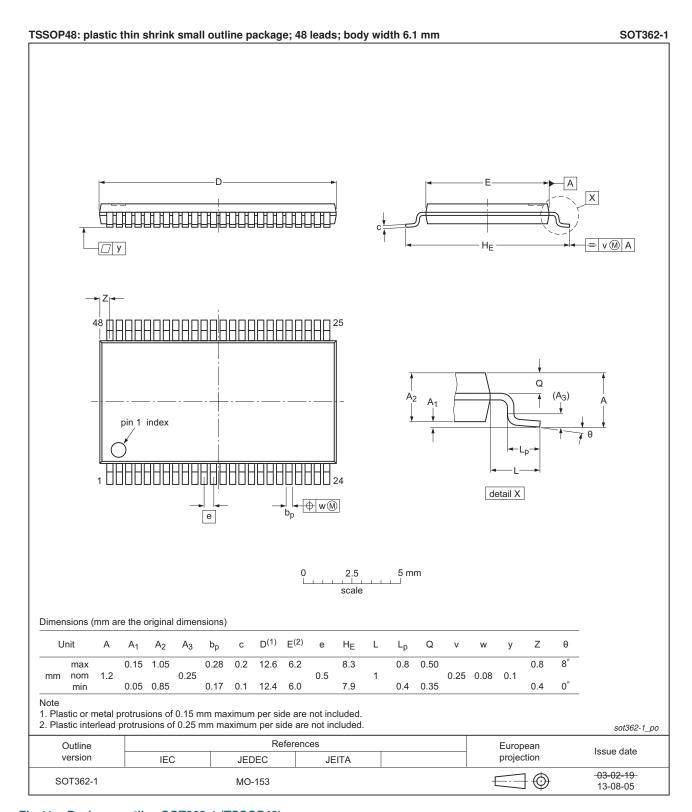


Fig 11. Package outline SOT362-1 (TSSOP48)

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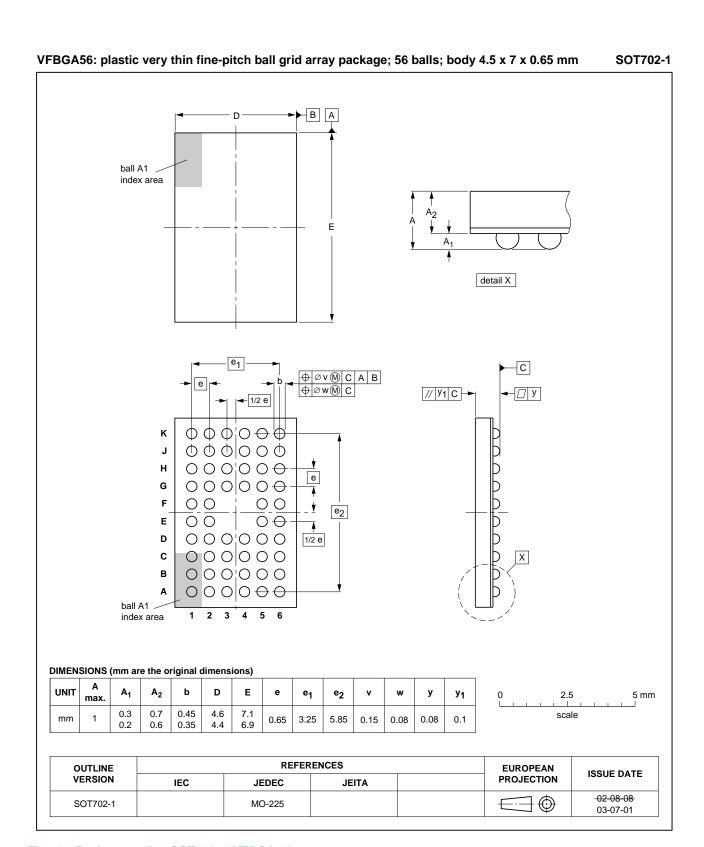


Fig 12. Package outline SOT702-1 (VFBGA56)

74LVC_LVCH16244A

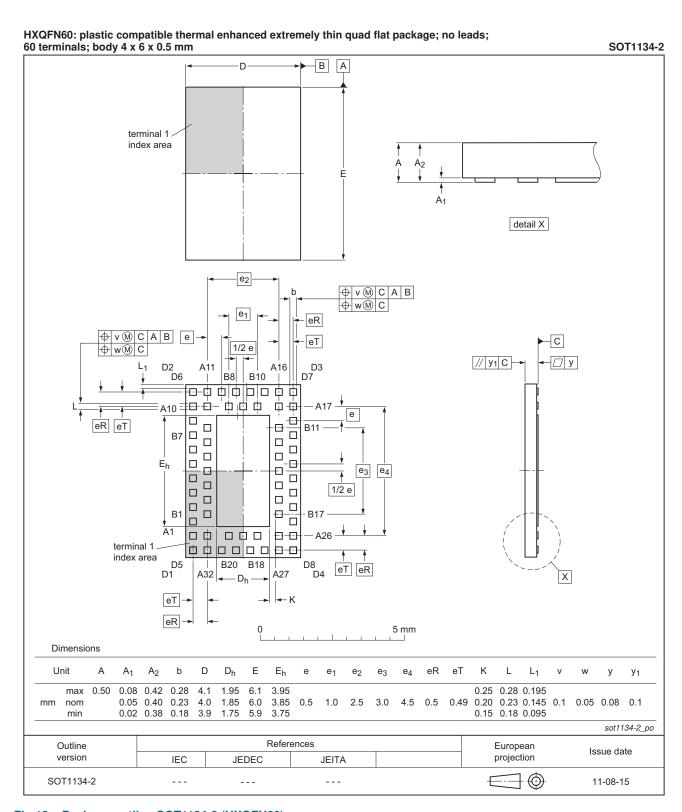


Fig 13. Package outline SOT1134-2 (HXQFN60)

74LVC_LVCH16244A

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13. Abbreviations

Table 10. Abbreviations

Acronym	Description
CDM	Charged Device Model
CMOS	Complementary Metal Oxide Semiconductor
DUT	Device Under Test
ESD	ElectroStatic Discharge
НВМ	Human Body Model
MM	Machine Model
TTL	Transistor-Transistor Logic

14. Revision history

Table 11. Revision history

Designant ID Delegas data Data sheet status Change matics Compared as					
Document ID	Release date	Data sheet status	Change notice	Supersedes	
74LVC_LVCH16244A v.13	20140207	Product data sheet	-	74LVC_LVCH16244A v.12	
Modifications:	 Table 5: Minim 	um V_{CC} changed from 2.	3 V to 1.65 V (errata).	
74LVC_LVCH16244A v.12	20120305	Product data sheet	-	74LVC_LVCH16244A v.11	
74LVC_LVCH16244A v.11	20111027	Product data sheet	-	74LVC_LVCH16244A v.10	
74LVC_LVCH16244A v.10	20110429	Product data sheet	-	74LVC_LVCH16244A v.9	
74LVC_LVCH16244A v.9	20100318	Product data sheet	-	74LVC_LVCH16244A v.8	
74LVC_LVCH16244A v.8	20081117	Product data sheet	-	74LVC_LVCH16244A v.7	
74LVC_LVCH16244A v.7	20031208	Product specification	-	74LVC_LVCH16244A v.6	
74LVC_LVCH16244A v.6	20030130	Product specification	-	74LVC_LVCH16244A v.5	
74LVC_LVCH16244A v.5	20021030	Product specification	-	74LVC_H16244A v.4	
74LVC_H16244A v.4	19971028	Product specification	-	74LVC16244A_ 74LVCH16244A v.3	
74LVC16244A_ 74LVCH16244A v.3	19971028	Product specification	-	74LVC16244A v.2	
74LVC16244A v.2	19970630	Product specification	-	74LVC16244A v.1	
74LVC16244A v.1	-	-	-	-	

15. Legal information

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Document status[1][2]	Product status[3]	Definition
Objective [short] data sheet	Development	This document contains data from the objective specification for product development.
Preliminary [short] data sheet	Qualification	This document contains data from the preliminary specification.
Product [short] data sheet	Production	This document contains the product specification.

- [1] Please consult the most recently issued document before initiating or completing a design.
- [2] The term 'short data sheet' is explained in section "Definitions"
- [3] The product status of device(s) described in this document may have changed since this document was published and may differ in case of multiple devices. The latest product status information is available on the Internet at URL http://www.nxp.com.

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

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74LVC16244A; 74LVCH16244A

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16-bit buffer/line driver; 5 V input/output tolerant; 3-state

17. Contents

1	General description
2	Features and benefits
3	Ordering information
4	Functional diagram 2
5	Pinning information 3
5.1	Pinning
5.2	Pin description 5
6	Functional description 5
7	Limiting values 6
8	Recommended operating conditions 6
9	Static characteristics 7
10	Dynamic characteristics 8
11	Waveforms
12	Package outline
13	Abbreviations
14	Revision history
15	Legal information
15.1	Data sheet status
15.2	Definitions
15.3	Disclaimers
15.4	Trademarks18
16	Contact information 18
17	Contents

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